

FEATURES

- 4 Matched NPN and 4 Matched PNP
- Monolithic Construction
- Low Noise
 - 0.75 nV/√Hz (PNP)
 - 0.8 nV/√Hz (NPN)
- High Speed
 - $f_T = 350$ MHz (NPN)
 - $f_T = 325$ MHz (PNP)
- Excellent Matching – 500 μ V typical between devices of same gender
- Dielectrically Isolated for low crosstalk, high DC isolation, and high temp operation
- 36V V_{CEO}

APPLICATIONS

- Microphone Preamplifiers
- Current Sources
- Current Mirrors
- Log/Antilog Amplifiers
- Multipliers
- Servos

Description

The THAT 380G is a large-geometry, 8-transistor, monolithic NPN/PNP array intended for use in multichip modules, hybrids, and chip-on-board applications. The individual devices exhibit both high speed and low noise, and are well-matched between transistors of the same gender.

Fabricated in a dielectrically isolated, complementary bipolar process, each transistor is electrically insulated from the others by a layer of insulating oxide (not the reverse-biased PN junctions used in conventional arrays) and exhibit inter-device crosstalk and DC isolation similar to that expected from discrete transistors. The resulting low collector-to-substrate capacitance produces a typical NPN f_T of 350MHz (325 MHz for the PNPs). Substrate biasing

is not required for normal operation, though the substrate should be grounded to optimize speed and minimize crosstalk.

While not guaranteed to meet its datasheet specifications outside the commercial temperature range, the transistors on the 380G will typically operate at much higher temperatures than ordinary junction-isolated devices with similar packing density.

Quad transistor arrays in DIP and SO packages with similar performance characteristics are also available from THAT Corporation. Please contact us directly or through your local distributor for more information.

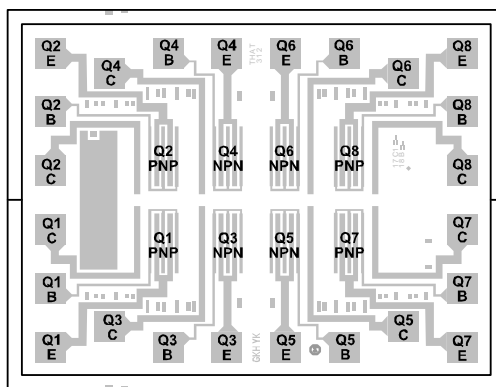


Figure 1. THAT 380G die layout

Die Thickness	Order Number
0.021"	380G21
0.014"	380G14

Table 1. Ordering Information

SPECIFICATIONS¹

Maximum Ratings (T_A = 25°C)						
Parameter	Symbol	Conditions	Min	Typ	Max	Units
NPN Collector-Emitter Voltage	BV _{CEO}	I _C = 1 mA, I _B = 0	36	40	—	V
NPN Collector-Base Voltage	BV _{CBO}	I _C = 10 μA, I _E = 0	36	40	—	V
NPN Emitter-Base Voltage	BV _{EBO}	I _E = 100 μA, I _C = 0	5	—	—	V
NPN Collector Current	I _{C MAX}		10	20		mA
NPN Emitter Current	I _{E MAX}		10	20		mA
PNP Collector-Emitter Voltage	BV _{CEO}	I _C = 1 mA, I _B = 0	-36	-40	—	V
PNP Collector-Base Voltage	BV _{CBO}	I _C = 10 μA, I _E = 0	-36	-40	—	V
PNP Emitter-Base Voltage	BV _{EBO}	I _E = 100 μA, I _C = 0	-5	—	—	V
PNP Collector Current	I _{C MAX}		-10	-20		mA
PNP Emitter Current	I _{E MAX}		-10	-20		mA
Collector-Collector Voltage	BV _{CC}		±100	±200	—	V
Emitter-Emitter Voltage	BV _{EE}		±100	±200	—	V
Operating Temperature Range	T _A		-40		+85	°C
Maximum Junction Temperature	T _{JMAX}				+150	°C
Storage Temperature	T _{STORE}		-45		+125	°C

NPN Electrical Characteristics²						
Parameter	Symbol	Conditions	Min	Typ	Max	Units
NPN Current Gain	h _{fe}	V _{CB} = 10 V I _C = 1 mA I _C = 10 μA	60	100 100	— —	
NPN Current Gain Matching	Δh _{fe}	V _{CB} = 10 V, I _C = 1 mA	—	5	—	%
NPN Noise Voltage Density	e _N	V _{CB} = 10 V, I _C = 1 mA, 1 kHz	—	0.8	—	nV/√Hz
NPN Gain-Bandwidth Product	f _T	I _C = 1 mA, V _{CB} = 10 V		350		MHz
NPN ΔV _{BE} (V _{BE3} -V _{BE4} ; V _{BE5} -V _{BE6})	V _{OS}	I _C = 1 mA I _C = 10 μA	—	±0.5 ±0.5	±3	mV mV

SPECIFICATIONS¹ (Cont'd)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
NPN ΔI_B ($I_{B3}-I_{B4}$, $I_{B5}-I_{B6}$)	I_{OS}	$I_C = 1\text{ mA}$ $I_C = 10\ \mu\text{A}$	— —	± 500 ± 5	± 1500	nA nA
NPN Collector-Base Leakage Current	I_{CBO}	$V_{CB} = 25\text{ V}$	—	25	—	pA
NPN Bulk Resistance	r_{BE}	$V_{CB} = 0\text{ V}$, $10\ \mu\text{A} < I_C < 10\text{ mA}$	—	2	—	Ω
NPN Base Spreading Resistance	r_{bb}	$V_{CB} = 10\text{ V}$, $I_C = 1\text{ mA}$	—	30	—	Ω
NPN Collector Saturation Voltage	$V_{CE(SAT)}$	$I_C = 1\text{ mA}$, $I_B = 100\ \mu\text{A}$	—	0.05	—	V
NPN Output Capacitance	C_{OB}	$V_{CB} = 10\text{ V}$, $I_E = 0\text{ mA}$, 100 kHz	—	3	—	pF
NPN Collector-Collector Capacitance (Q3-Q4, Q5-Q6)	C_{CC}	$V_{CC} = 0\text{ V}$, 100 kHz	—	0.7	—	pF

PNP Electrical Characteristics²

Parameter	Symbol	Conditions	Min	Typ	Max	Units
PNP Current Gain	h_{ie}	$V_{CB} = 10\text{ V}$ $I_C = 1\text{ mA}$ $I_C = 10\ \mu\text{A}$	50	75 75	— —	
PNP Current Gain Matching	Δh_{ie}	$V_{CB} = 10\text{ V}$, $I_C = 1\text{ mA}$	—	5	—	%
PNP Noise Voltage Density	e_N	$V_{CB} = 10\text{ V}$, $I_C = 1\text{ mA}$, 1 kHz	—	0.75	—	nV $\sqrt{\text{Hz}}$
PNP Gain-Bandwidth Product	f_T	$I_C = 1\text{ mA}$, $V_{CB} = 10\text{ V}$	—	325	—	MHz
PNP ΔV_{BE} ($V_{BE1}-V_{BE2}$; $V_{BE7}-V_{BE8}$)	V_{OS}	$I_C = 1\text{ mA}$ $I_C = 10\ \mu\text{A}$	— —	± 0.5 ± 0.5	± 3	mV mV
PNP ΔI_B ($I_{B1}-I_{B2}$; $I_{B7}-I_{B8}$)	I_{OS}	$I_C = 1\text{ mA}$ $I_C = 10\ \mu\text{A}$	— —	± 700 ± 7	± 1800	nA nA
PNP Collector-Base Leakage Current	I_{CBO}	$V_{CB} = 25\text{ V}$	—	-25	—	pA
PNP Bulk Resistance	r_{BE}	$V_{CB} = 0\text{ V}$, $10\ \mu\text{A} < I_C < 10\text{ mA}$	—	2	—	Ω
PNP Base Spreading Resistance	r_{bb}	$V_{CB} = 10\text{ V}$, $I_C = 1\text{ mA}$	—	25	—	Ω
PNP Collector Saturation Voltage	$V_{CE(SAT)}$	$I_C = 1\text{ mA}$, $I_B = 100\ \mu\text{A}$	—	-0.05	—	V
PNP Output Capacitance	C_{OB}	$V_{CB} = 10\text{ V}$, $I_E = 0\text{ mA}$, 100 kHz	—	3	—	pF
PNP Collector-Collector Capacitance (Q1-Q2; Q7-Q8)	C_{CC}	$V_{CC} = 0\text{ V}$, 100 kHz	—	0.6	—	pF

1. All specifications are subject to change without notice.
2. Unless otherwise noted, $T_A = 25^\circ\text{C}$.

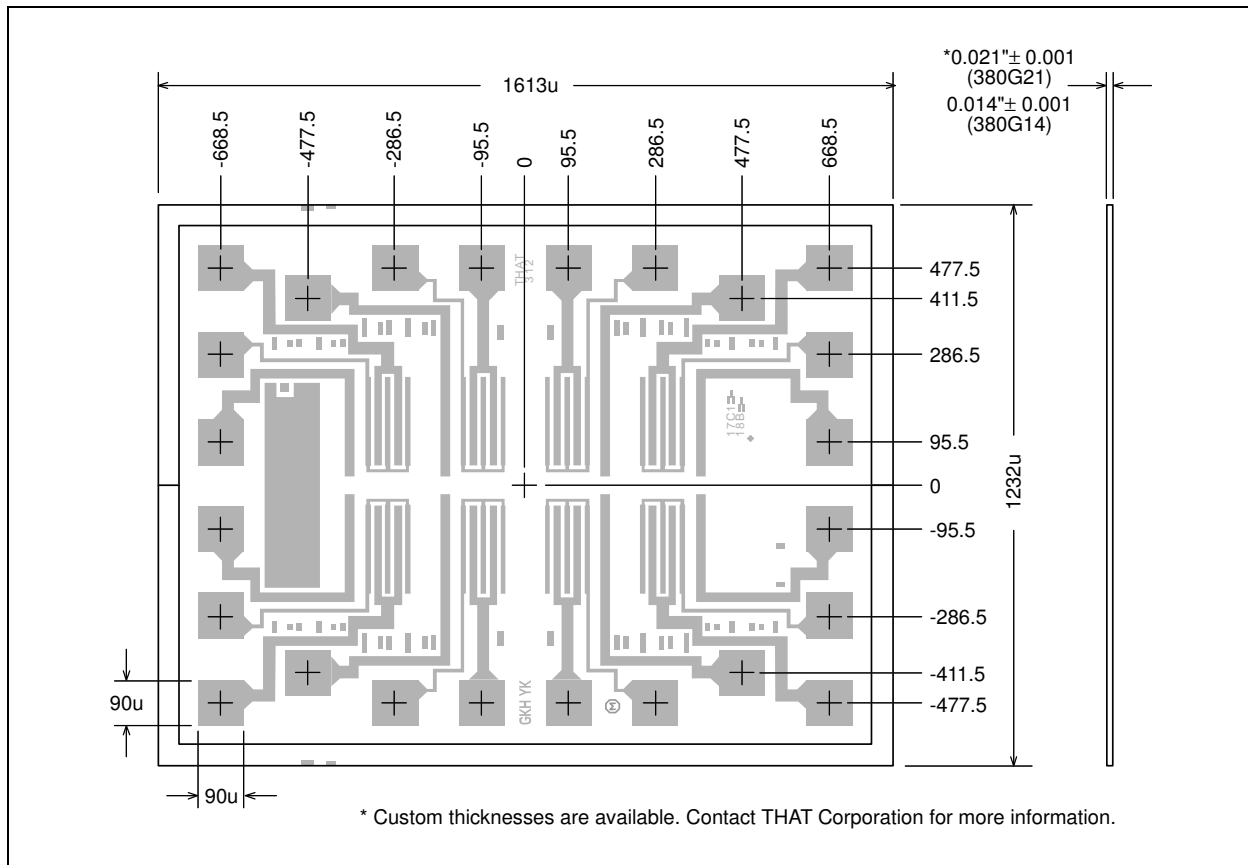


Figure 2. Die dimensions

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CAUTION: THIS IS AN ESD (ELECTROSTATIC DISCHARGE) SENSITIVE DEVICE.

It can be damaged by the currents generated by electrostatic discharge. Static charge and therefore dangerous voltages can accumulate and discharge without detection causing a loss of function or performance to occur.

The transistors in this device are unprotected in order to maximize performance and flexibility. They are more sensitive to ESD damage than many other ICs which include protection devices at their inputs. Note that all of the pins (not just the "inputs") are susceptible.

Use ESD preventative measures when storing and handling this device. Unused devices should be stored in conductive packaging. Packaging should be discharged to the destination socket before the devices are removed. ESD damage can occur to these devices even after they are installed in a board-level assembly. Circuits should include specific and appropriate ESD protection.